

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5660581

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	WEI CHEN	05/15/2019
	ESWARAMOORTHY NALLUSAMY	03/14/2019
	LARISA NOVAKOVSKY	08/08/2019
	MARK SCHMISSEUR	03/12/2019
	ERIC RASMUSSEN	04/03/2019
	STEPHEN VAN DOREN	06/12/2019
	YEN-CHENG LIU	03/12/2019
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	INTEL CORPORATION	
<b>Street Address:</b>	2200 MISSION COLLEGE BOULEVARD	
<b>City:</b>	SANTA CLARA	
<b>State/Country:</b>	CALIFORNIA	
<b>Postal Code:</b>	95054	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	16264447
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
<b>Email:</b>	asahagian@ghmip.com	
<b>Correspondent Name:</b>	GREEN, HOWARD, & MUGHAL LLP	
<b>Address Line 1:</b>	5 CENTERPOINTE DR.	
<b>Address Line 4:</b>	LAKE OSWEGO, OREGON 97035	
<b>ATTORNEY DOCKET NUMBER:</b>	01.AA4466-US	
<b>NAME OF SUBMITTER:</b>	ADAM SAHAGIAN	
<b>SIGNATURE:</b>	/Adam Sahagian/	
<b>DATE SIGNED:</b>	08/08/2019	
<b>Total Attachments: 14</b>		

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In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

**Wei Chen; Eswaramoorthi Nallusamy; Larisa Novakovsky;  
Mark Schmisser; Eric Rasmussen; Stephen Van Doren; Yen-Cheng Liu**

hereby sell, assign, and transfer to:

**Intel Corporation**

a corporation of Delaware, having a principal place of business at 2200 Mission College Blvd. Santa Clara, CA. 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

### **DEVICE, SYSTEM AND METHOD TO FACILITATE DISASTER RECOVERY FOR A MULTI-PROCESSOR PLATFORM**

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on January 31, 2019 as

United States Application Number 16/264,447 and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

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covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Cheri

Wei Chen

5/18/2019

Date signed

Eswaramoorthi Nallusamy

Date signed \_\_\_\_\_

Larisa Novakovsky

Date signed \_\_\_\_\_

Mark Schmisser

Date signed \_\_\_\_\_

Eric Rasmussen

Date signed \_\_\_\_\_

Stephen Van Doren

Date signed

Yen-Cheng Liu

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Date signed

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Eswaramoorthi Nallusamy

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\_\_\_\_\_  
Larisa Novakovsky

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Date signed

\_\_\_\_\_  
Mark Schmisser

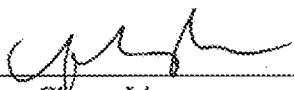
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Yen-Cheng Liu

03/12/19  
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\_\_\_\_\_  
Wei Chen



\_\_\_\_\_  
Eswaramoorthi Nallusamy

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Date signed

03/14/2019

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Date signed

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Larisa Novakovsky

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_____ Wei Chen	_____ Date signed
_____ Eswarnoorthi Nallusamy	_____ Date signed
_____  Larisa Novakovsky	_____ 8.08. 2013 Date signed
_____ Mark Schmisseeur	_____ Date signed
_____ Eric Rasmussen	_____ Date signed
_____ Stephen Van Doren	_____ Date signed
_____ Yen-Cheng Liu	_____ Date signed

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Wei Chen

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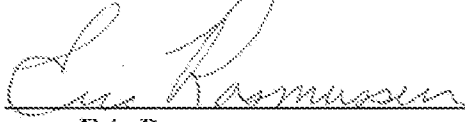
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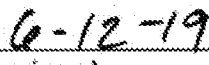
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